瀚荃股份有限公司
CviLux Corporation

CVILUX
2020.07.31
ISSUED

ENGINEERING DEPT.		PRODUCT SPECIFICATION	SPEC.NO.: SPCI095D
REVISIONS	ECNT120150	For CI07 Latch Type Connector	PAGE: 1/4

1. SCOPE:
This specification contains the test requirement of subject connectors when tested under the condition andprocedure with terminals crimped on the specified maximum size wire

2. APPLICABLE STANDARDS:

MIL - STD - 202	Methods for test of connectors for electronic equipment
EIA - 364	Test methods for electrical connectors
J-STD-020	Resistance to soldering Temperature for through hole Mounted Devices
SS-00254	Test methods for electronic components ,LEAD-FREE soldering Part design standards

3. APPLICABLE SERIES NO.: Housing: CI0702SL0**-NH
Header: CI0702M1*R*-NH (Halogen-Free)
Terminal: CI07T021PE0 (For AWG #22~#26)
CI07T011PE0 (For AWG #28~#30)

4. SHAPE, CONSTRUCTION AND DIMENSIONS
See attached drawings

5. MATERIALS
See attached drawings

6. ACCOMMODATED P.C.BOARD
6.1 P.C. Board Layout: See attached drawings

REVIEWED : Eisley APPROVED : Sun VERIFIED : Michelle .

ENGINEERING DEPT.		PRODUCT SPECIFICATION For CI07 Latch Type Connector	SPEC.NO.: SPCI095D
REVISIONS	ECNT120150		PAGE: 2/4

7. ELECTRICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
7.1	Rated current and voltage		4A (AWG #22) , 350V AC/DC
7.2	Contact resistance	Dry circuit of DC 20mV max. , 100mA max., Wire resistance shell be removed from the measured value.	Less than 10 mΩ
7.3	Dielectric strength	When applied AC 1700 V 1 minute between adjacent terminal	No Breakdown
7.4	Insulation resistance	When applied DC 500 V between adjacent terminal or ground	More than 1000 MΩ

8. MECHANICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT	
8.1	Wire size	Specified wire size	Accepts AWG#22-#30	
8.2	Terminal crimp strength	When crimped AWG#22 size wire	More than 5.0 kgf.	
		When crimped AWG#24 size wire	More than 3.0kgf	
		When crimped AWG#26 size wire	More than 2.0 kgf	
		When crimped AWG#28 size wire	More than 1.3 kgf	
		When crimped AWG#30 size wire	More than 0.8 kgf	
8.3	Terminal insertion force	Insertion speed 25± 3 mm per minute into housing	Less than 0.6 Kgf	
8.4	Terminal retaining force in insulator	Retention speed 25± 3 mm per minute from Housing	More than 0.7 kgf	
8.5	Pin retention force in Board mount Header	Push Pin from insulator base at speed 25± 3 mm per minute	More than 0.4 kgf	
8.6	Single contact insertion force	Measure force to insertion using mating pin at speed 25± 3 mm per minute	600 gram max.	
8.7	Single contact withdrawal force	Measure force to withdrawal using mating pin at speed 25± 3 mm per minute	50 gram min.	
8.8	Mating and Unmating force(Remove Locking Ramp)	Speed 25± 3 mm per minute	Mating (Max.)	Unmating (Min.)
			2.0 kgf	0.2 kgf
8.9	Latch Type force	Speed 25± 3 mm per minute	More than 2.0 kgf	
8.10	Durability	Connector shall be subjected to 30 cycles of insertion and withdrawal	Contact resistance: Less than twice of initial	

9. ENVIRONMENTAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
9.1	Temperature rise	Then carried the rated current	30°C max.
9.2	Vibration	1.5 mm 10-55-10 HZ/minute each 2 hours for X, Y and Z directions	Appearance: No damage Discontinuity: 1 micro second max.
9.3	Heat aging	85± 2°C, 96 hours	No damage
9.4	Humidity	40± 2°C, 90-95% RH, 96 hours measurement must be taken within 30 min. after tested	Appearance: No damage Contact resistance: Less than twice of initial Dielectric strength: To pass para 7-3
9.5	Temperature cycling	One cycle consists of : (1) -55 $^{+0}_{-3}$ °C , 30 min. (2) Room temp. 10-15 min. (3) 85 $^{+3}_{-0}$ °C , 30 min. (4) Room temp. 10-15 min. Total cycle: 5 cycle	Appearance: No damage Contact resistance: Less than twice of initial
9.6	Salt spray	Temperature: 35 ± 3°C Solution: 5 ± 1% Spray time: 48 ± 4 hours (Stamping before plated) Spray time: 24 ± 4 hours (Stamping after plated) Mate connectors and expose to the following salt mist conditions. Upon completion of the exposure period, salt deposits shall be removed by a gentle wash or dip in running water and dried naturally, after which the specified measurements shall be performed. The specimens shall be suspended from the top using waxed twine, string or nylon thread. The test only define the plating area, without plating area (as copper cross section) will not be defined. (EIA 364-26B / MIL-STD-202 Method 101)	Appearance: No damage Contact resistance: Less than twice of initial

ENGINEERING DEPT.		PRODUCT SPECIFICATION	SPEC.NO.: SPCI095D
REVISIONS	ECNT120150	For CI07 Latch Type Connector	PAGE: 4/4

	ITEM	TEST CONDITION	REQUIREMENT
9.7	Solder ability	Soldering time: 3 ± 0.5 second Soldering pot: 245 ± 5°C	Minimum: 90% of immersed area
9.8	Resistance to soldering heat	Refer Reflow temperature profile(11.1)	No damage

10. AMBIENT TEMPERATURE RANGE: -25 to + 85°

11. Recommended IR Reflow Temperature Profile:
11.1 Using Lead-Free Solder Paste